The XA3200 is a low noise, constant frequency (400kHz) switched capacitor voltage doubler. It produces a regulated output voltage from a 2.5V to 4.5V input with up to 250mA of output current. Low external parts count (one flying capacitor and two small bypass capacitors at VIN and VOUT) make the XA3200 ideally suited for small, battery-powered applications.

A new charge-pump architecture maintains constant switching frequency to zero load and reduces both output and input ripple. The XA3200 have thermal shutdown capability and can survive a continuous short circuit from VOUT to GND. Built-in soft-start circuitry prevents excessive inrush current during start-up.

High switching frequency enables the use of small ceramic capacitors. A low current shutdown feature disconnects the load from VIN and reduces quiescent current to <1µA.

The XA3200 is available in the industry standard SOT-23-6 power packages.

Features
- Fixed 5V ± 4% Output
- VIN Range: 2.5V to 5V
- Output Current: Up to 250mA
- Constant Frequency Operation at All Loads
- Low Noise Constant Frequency (400kHz) Operation
- Automatic Soft-Start Reduces Inrush Current
- Shutdown Current <1µA
- Short-Circuit Protection
- No Inductors
- Available in Low Profile 6-Lead SOT23 Package

Description

Application
- White LED Backlighting
- Li-Ion Battery Backup Supplies
- Local 3V to 5V Conversion
- Smart Card Readers
- PCMCIA Local 5V Supplies
Typical Applications

Figure 1: Regulated 5V Output

Figure 2: USB Port to Regulated 5V Power Supply

Figure 3: Lithium-Ion Battery to 5V White or Blue LED Drivers

Pin Description

<table>
<thead>
<tr>
<th>PIN NUMBER</th>
<th>PIN NAME</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>VOUT</td>
</tr>
<tr>
<td>2</td>
<td>GND</td>
</tr>
<tr>
<td>3</td>
<td>EN</td>
</tr>
<tr>
<td>4</td>
<td>C-</td>
</tr>
<tr>
<td>5</td>
<td>VIN</td>
</tr>
<tr>
<td>6</td>
<td>C+</td>
</tr>
</tbody>
</table>
Absolute Maximum Ratings (Note 1)

- $V_{IN}$: $0.3\text{V}$ to $6\text{V}$
- $V_{OUT}$: $0.3\text{V}$ to $5.5\text{V}$
- Short-circuit Duration: indefinite
- $V_{EN}$: $0.3\text{V}$ to $6\text{V}$
- $I_{OUT}$ (Note 2): $300\text{mA}$
- Operating Temperature Range (Note 3): $-30^\circ\text{C}$ to $85^\circ\text{C}$
- Lead Temperature (Soldering 10 sec.): $300^\circ\text{C}$
- Storage Temperature Range: $-65^\circ\text{C}$ to $125^\circ\text{C}$

Note 1: Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.

Note 2: Based on long term current density limitations.

Note 3: The XA3200 are guaranteed to meet performance specifications from $0^\circ\text{C}$ to $70^\circ\text{C}$. Specifications over the $-40^\circ\text{C}$ to $85^\circ\text{C}$ operating temperature range are assured by design, characterization and correlation with statistical process controls.

Electrical Characteristics

The specifications are at $TA = 25^\circ\text{C}$. $EN = V_{IN}$, $C_{IN} = C_{OUT} = 2.2\mu\text{F}$ unless otherwise noted.

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>CONDITIONS</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNITS</th>
</tr>
</thead>
<tbody>
<tr>
<td>Input Voltage Range ($V_{IN}$)</td>
<td></td>
<td>2.5</td>
<td>5.5</td>
<td></td>
<td>V</td>
</tr>
<tr>
<td>Output Voltage Range ($V_{OUT}$)</td>
<td>$2.7V &lt; V_{IN} &lt; 5.5V$, $I_{OUT} &lt; 65mA$</td>
<td>4.7</td>
<td>5</td>
<td>5.2</td>
<td>V</td>
</tr>
<tr>
<td>$I_{SHDN}$ Shutdown Current</td>
<td>$EN=0V, V_{OUT} = 0V$</td>
<td>0.3</td>
<td></td>
<td></td>
<td>$\mu\text{A}$</td>
</tr>
<tr>
<td>No load input current</td>
<td>$I_{OUT} = 0\text{mA}$, $V_{IN} = 2.7V$</td>
<td>0.65</td>
<td></td>
<td></td>
<td>mA</td>
</tr>
<tr>
<td>Output current limit</td>
<td></td>
<td>250</td>
<td></td>
<td></td>
<td>mA</td>
</tr>
<tr>
<td>Output Ripple (VR)</td>
<td>$V_{IN} = 2.7V$, $I_{OUT} = 100mA$</td>
<td>150</td>
<td></td>
<td></td>
<td>mVP-P</td>
</tr>
<tr>
<td>Efficiency</td>
<td>$V_{IN} = 2.7V$, $I_{OUT} = 100mA$</td>
<td>81</td>
<td></td>
<td></td>
<td>%</td>
</tr>
<tr>
<td>Open-Loop Output Resistance R_{OL}</td>
<td>$V_{IN} = 2.7V$, $I_{OUT} = 100mA$</td>
<td>4</td>
<td></td>
<td></td>
<td>$\Omega$</td>
</tr>
<tr>
<td>Switching Frequency ($f_{osc}$)</td>
<td></td>
<td>400</td>
<td></td>
<td></td>
<td>kHz</td>
</tr>
</tbody>
</table>

$\text{EFFI} = \frac{(\text{Output Voltage} \times \text{Output Current})}{(\text{Input Voltage} \times \text{Input Current})} \times 100\%$
Typical Performance Characteristics

**Efficiency vs. Output Current**

- Efficiency vs. Output Current with different Supply Voltage levels:
  - $V_{IN}=2.8V$
  - $V_{IN}=4.2V$
  - $V_{IN}=3.6V$

**Output Voltage vs. Supply Voltage**

- Output Voltage remains relatively constant across different Supply Voltage levels.

**No Load Supply Current vs. Supply Voltage**

- No Load Supply Current decreases as Supply Voltage increases.

**Oscillator Frequency vs. Supply Voltage**

- Oscillator Frequency decreases as Supply Voltage increases.

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Pin Functions

**VOUT (Pin 1):** Regulated Output Voltage. VOUT should be bypassed with a low ESR ceramic capacitor providing at least 2µF of capacitance as close to the pin as possible for best performance.

**GND (Pin 2):** Ground. These pins should be tied to a ground plane for best performance. The exposed pad must be soldered to PCB ground to provide electrical contact and optimum thermal performance.

**EN (Pin 3):** Active Low Shutdown Input. This pin must not be allowed to float.

**C- (Pin 4):** Flying Capacitor Negative Terminal.

**VIN (Pin 5):** Input Supply Voltage. VIN should be bypassed with a 1µF to 4.7µF low impedance ceramic capacitor.

**C+ (Pin 6):** Flying Capacitor Positive Terminal.
Application Information

Operation

The XA3200 use a switched capacitor charge pump to boost VIN to a regulated output voltage. Regulation is achieved by sensing the output voltage through an internal resistor divider and modulating the charge pump output current based on the error signal. A 2-phase nonoverlapping clock activates the charge pump switches. The flying capacitor is charged from VIN on the first phase of the clock. On the second phase of the clock it is stacked in series with VIN and connected to VOUT. This sequence of charging and discharging the flying capacitor continues at a free running frequency of 0.4MHz (typ).

In shutdown mode all circuitry is turned off and the XA3200 draw only leakage current from the VIN supply. Furthermore, VOUT is disconnected from VIN. The EN pin is a CMOS input with a threshold voltage of approximately 0.8V. The XA3200 is in shutdown when a logic low is applied to the EN pin. Since the EN pin is a high impedance CMOS input it should never be allowed to float. To ensure that its state is defined it must always be driven with a valid logic level.

Short-Circuit Protection

The XA3200 have built-in short-circuit current limiting. During short-circuit conditions, they will automatically limit their output current to approximately 200mA.

Soft-Start

The XA3200 have built-in soft-start circuitry to prevent excessive current flow at VIN during start-up. The soft-start time is preprogrammed to approximately 1ms, so the start-up current will be primarily dependent upon the output capacitor.

VIN, VOUT Capacitor Selection

The style and value of capacitors used with the XA3200 determine several important parameters such as regulator control loop stability, output ripple, charge pump strength and minimum start-up time.

To reduce noise and ripple, it is recommended that low ESR (< 0.1Ω) ceramic capacitors be used for both CIN and COUT. These capacitors should be 0.47uF or greater. Tantalum and aluminum capacitors are not recommended because of their high ESR.

The value of COUT directly controls the amount of output ripple for a given load current. Increasing the size of COUT will reduce the output ripple at the expense of higher minimum turn on time and higher start-up current. The peak-to-peak output ripple is approximately given by the expression:

\[ \text{V}_{\text{RIPPLE}} = \frac{I_{\text{OUT}}}{2f_{\text{OSC}} \cdot C_{\text{OUT}}} \]

Where \( f_{\text{OSC}} \) and \( C_{\text{OUT}} \) is the output charge storage capacitor.
Both the style and value of the output capacitor can significantly affect the stability of the XA3200. The XA3200 uses a linear control loop to adjust the strength of the charge pump to match the current required at the output. The error signal of this loop is stored directly on the output charge storage capacitor. The charge storage capacitor also serves to form the dominant pole for the control loop. To prevent ringing or instability on the XA3200 it is important for the output capacitor to maintain at least 0.47uF of capacitance over all conditions.

Likewise excessive ESR on the output capacitor will tend to degrade the loop stability of the XA3200. Ceramic capacitors typically have exceptional ESR performance and combined with a tight board layout should yield very good stability and load transient performance.

As the value of COUT controls the amount of output ripple, the value of CIN controls the amount of ripple present at the input pin (VIN). The input current to the XA3200 will be relatively constant while the charge pump is either the input charging phase or the output charging phase but will drop to zero during the clock nonoverlap times. Since the nonoverlap time is small (~25ns), these missing “notches” will result in only a small perturbation on the input power supply line. Note that a higher ESR capacitor such as tantalum will have higher input noise due to the input current change times the ESR. Therefore ceramic capacitors are again recommended for their exceptional ESR performance.

Flying Capacitor Selection

Warning: A polarized capacitor such as tantalum or aluminum should never be used for the flying capacitor since its voltage can reverse upon start-up of should always be used for the flying capacitor.

The flying capacitor controls the strength of the charge pump. In order to achieve the rated output current it is necessary to have at least 0.68uF of capacitance for the flying capacitor.

For very light load applications the flying capacitor may be reduced to save space or cost. The theoretical minimum output resistance of a voltage doubling charge pump is given by:

\[
R_{CL(MIN)} = \frac{2V_{IN} - V_{OUT}}{I_{OUT}} = \frac{1}{f_{OSC} \cdot \text{CFLY}}
\]

Where \(f_{OSC}\) is the switching frequency (0.4Hz typ) and CFLY is the value of the flying capacitor. The charge pump will typically be weaker than the theoretical limit due to additional switch resistance, however for very light load applications the above expression can be used as a guideline in determining a starting capacitor value.

Power Efficiency

The power efficiency of the XA3200 is similar to that of a linear regulator with an effective input voltage of twice the actual input voltage. This occurs because the input current for a voltage doubling charge pump is approximately twice the output current. In an ideal regulating voltage doubler the power efficiency would be given by:

\[
\eta = \frac{P_{OUT}}{P_{IN}} = \frac{V_{OUT} \cdot I_{OUT}}{V_{IN} \cdot 2I_{OUT}} = \frac{V_{OUT}}{2V_{IN}}
\]
At moderate to high output power the switching losses and quiescent current of the XA3200 are negligible and the expression above is valid. For example with \( V_{IN} = 3\, \text{V} \), \( I_{OUT} = 50\, \text{mA} \) and \( V_{OUT} = 5\, \text{V} \) the measured efficiency is 80% which is in close agreement with the theoretical 83.3% calculation.

**Layout Considerations**

Due to its high switching frequency and the high transient currents produced by the XA3200, careful board layout is necessary. A true ground plane and short connections to all capacitors will improve performance and ensure proper regulation under all conditions. Figure 4 shows an example layout for the XA3200.

![Figure 4: Recommended Layout](image)
### Packaging Information

SOT-23-6 Package Outline Dimension

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Dimensions In Millimeters</th>
<th>Dimensions In Inches</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td>Min</td>
<td>Max</td>
</tr>
<tr>
<td>A</td>
<td>1.050</td>
<td>1.250</td>
</tr>
<tr>
<td>A1</td>
<td>0.000</td>
<td>0.100</td>
</tr>
<tr>
<td>A2</td>
<td>1.050</td>
<td>1.150</td>
</tr>
<tr>
<td>b</td>
<td>0.300</td>
<td>0.500</td>
</tr>
<tr>
<td>c</td>
<td>0.100</td>
<td>0.200</td>
</tr>
<tr>
<td>D</td>
<td>2.820</td>
<td>3.020</td>
</tr>
<tr>
<td>E</td>
<td>1.500</td>
<td>1.700</td>
</tr>
<tr>
<td>E1</td>
<td>2.650</td>
<td>2.950</td>
</tr>
<tr>
<td>e</td>
<td>0.950 (BSC)</td>
<td>0.037 (BSC)</td>
</tr>
<tr>
<td>e1</td>
<td>1.800</td>
<td>2.000</td>
</tr>
<tr>
<td>L</td>
<td>0.300</td>
<td>0.600</td>
</tr>
<tr>
<td>θ</td>
<td>0°</td>
<td>8°</td>
</tr>
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